

BASIC BLADE & BEAM SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?BSH

Insulator Material: Black LCP

Contact Material: Phosphor Bronze

Plating: Au or Sn over 50μ" (1,27μm) Ni Current Rating: 1.25A @ 80°C ambient

1.25A @ 80°C ambient Flammability Rating: UL 94 VO

Operating Temp Range: -55°C to +125°C

Voltage Rating: 125 VAC Max Cycles:

100 RoHS Compliant:

Yes

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (030-090) (0,15mm) .006" max (120-150)

(0,15mm) .006" max (120-150)

Board Stacking:
For applications requiring

For applications requiring more than two connectors per board or 90 positions or higher, contact ipg@samtec.com

NO. OF POSITIONS PLATING BSH 01 **PER ROW OPTION** OPTION Mates with: BTH -TR = Gold Flash on contact, Matte Tin on tail =Tape & Reel **–030, –050, –060,** (120 positions -090, -120, -150 maximum) = 10μ" (0,25μm) Gold on contact, Matte Tin on tail -C* No. of Positions x (0,50) .01969 + (6,27) .247 = Electro-Polished Selective 50μ" (1,27μm) min Au over 150μ" (3,81μm) Ni on Signal Pins in contact (3,81μm) Ni on Signal Pins in contact area, 10μ" (0,25μm) min Au over 50μ" (1,27μm) Ni on Ground Plane in contact area, Matte Tin over 50μ" (1,27μm) min Ni on all solder tails (6,22) .245 (3,81) (7,24) .285 .150 (0,50) -.01969 AGILENT LOGIC ANALYZER TEST POINT (0,15)**CONNECTOR** (0,89) .035 (3,05).Ó06 (0,76) Specify: ASP-65067-01 128

MATED HEIGHT

LEAD STYLE	MATED HEIGHT*
-01	(5,00) .197
*Processing conditions will affect mated height.	

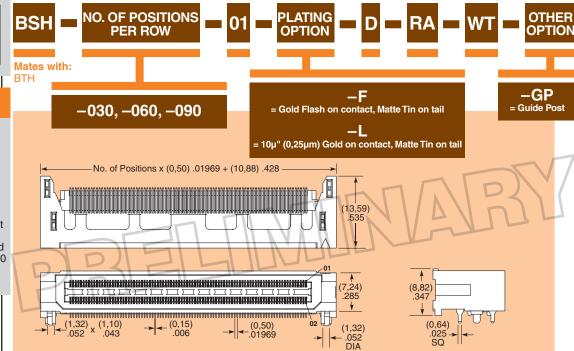
APPLICATION SPECIFIC

- 30µ" (0,76µm) Gold
- Edge Mount Capability
- 8mm, 11mm, 16mm, 19mm and 22mm Stack Height (Caution: Some automatic placement/ inspection machines may have component height restrictions. Please consult machinery specifications.) (11mm, 16mm, 19mm and 22mm not available with 50 positions)

Call Samtec.

*Note: –C Plating passes 10 year MFG testing Note: Some lengths, style

Note: Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice.

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